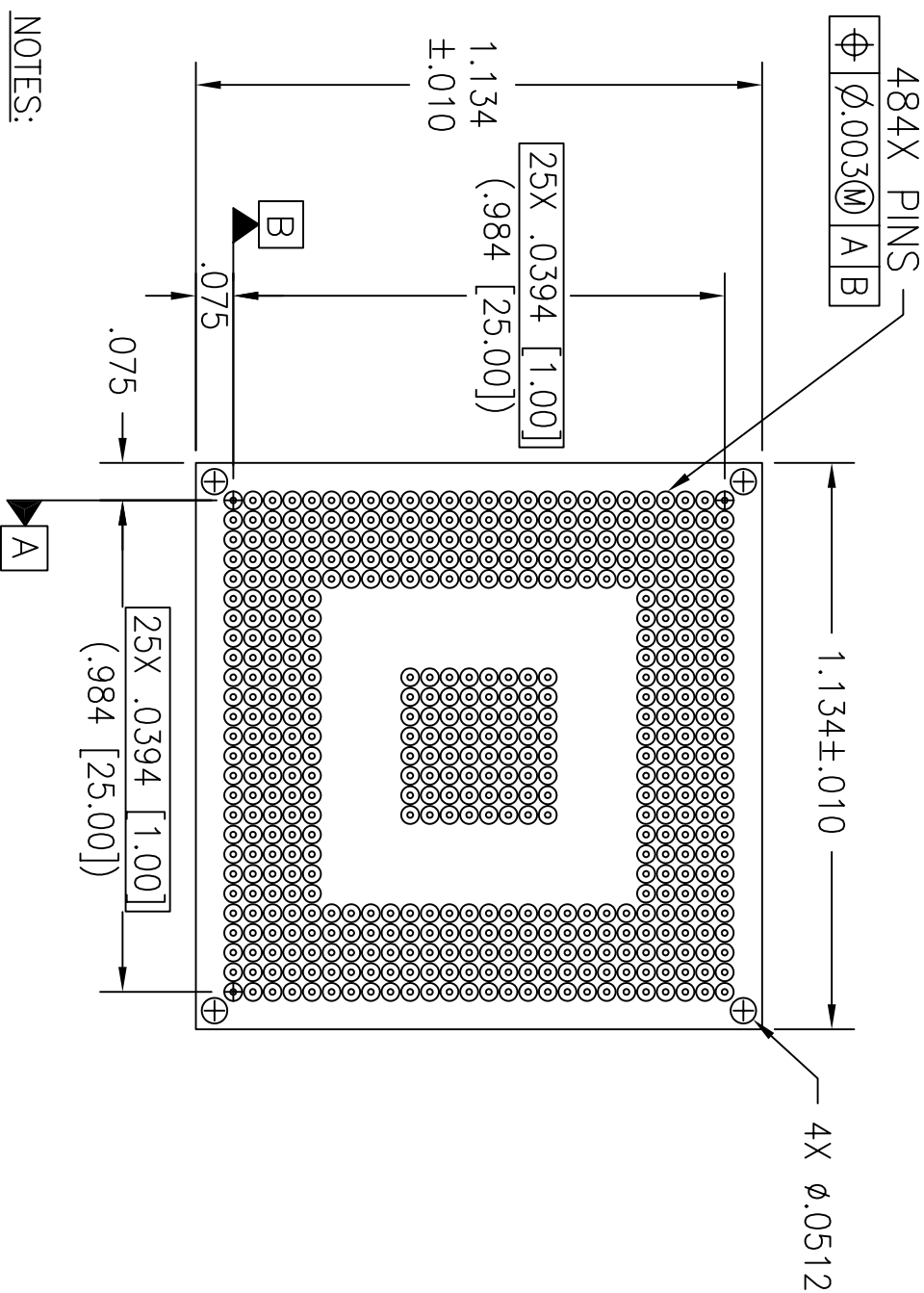
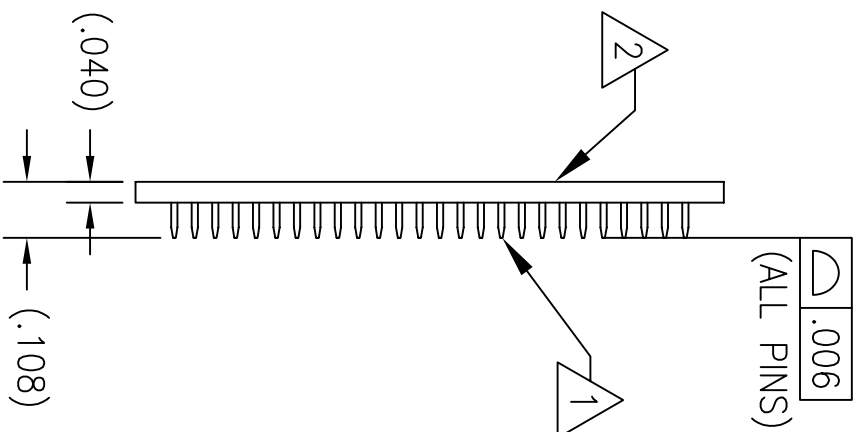


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TOP VIEW



RS VIEW



- NOTES:
- PINS $\Phi .01117$
 MATERIAL: PHOSPHOR BRONZE.
 PLATING: HARD GOLD OVER NICKEL.
 - INSULATOR MATERIAL: FR4.

REV	DESCRIPTION	EGN	DATE	RELEASE
1	SALES RELEASE			

UNLESS OTHERWISE SPECIFIED:		DRAWN BY		DATE	
DIMENSIONS ARE IN INCHES		DESIGNER		DATE	
TOLERANCES: ±		CHECKER		DATE	
FRACTIONS: 1/64		DATE		DATE	
DECIMALS: ±.010		DATE		DATE	
XXX ±.005		DATE		DATE	
.XXX ±.005		DATE		DATE	

CONTRACT NO.	TITLE	SCALE	DRAWING NO.
	 INTERCONNECT SYSTEMS INC. 708 VIA ALONDRA, CAMARILLO, CA 93012 HIL0-BGA PIN BASE 26 X 26, 484 PINS 1mm PITCH	N/A	HLP-260484-B-10

SAWD AS: HLP-260484-B-10.DWG	FINISHED AS: HLP-260484-B-10	SHEET 1 OF 1
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